

Carrier_BT807042_SOIC-8_v LCP



Part number	78 01 030 0004
Specification	Carrier_BT807042_SOIC-8_v LCP
HARTING eCatalogue	https://harting.com/78010300004

Image is for illustration purposes only. Please refer to product description.

Identification

Category	Surface Mount Device
Series	3D-MID
Element	Carrier for electronic components
Specification	Interconnection
Features	Other materials or trace layouts on request!

Version

Fixing	PCB assembly (SMD)
Pack contents	Tape & reel 1200 pieces on reel
	Lower quantities available on request!

Technical characteristics

Operating temperature	-40 +125 °C
Storage temperature	-40 +125 °C

Material properties

Material	Liquid crystal polymer (LCP)
Surface (contacts)	Au (≥ 0.05 μm) over Ni (≥ 4 μm) over Cu (511 μm)
Length	8 mm
Width	7 mm
Height	4.2 mm
RoHS	compliant
ELV status	compliant

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Material properties

China RoHS	е
REACH Annex XVII substances	Not contained
REACH ANNEX XIV substances	Not contained
REACH SVHC substances	Not contained
California Proposition 65 substances	Not contained

Commercial data

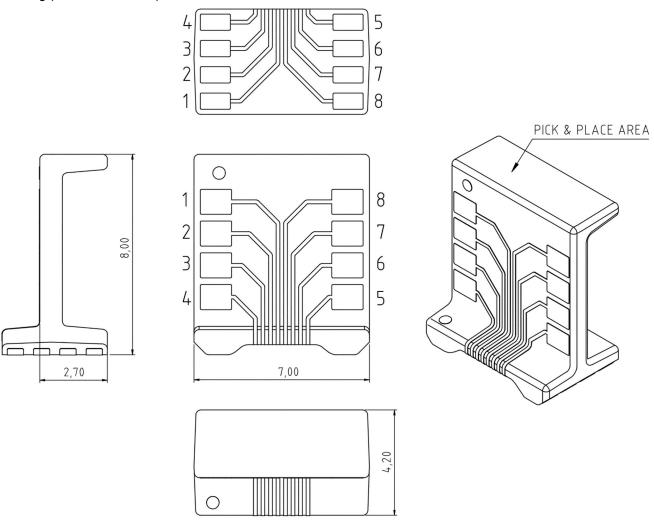
Packaging size	600
Net weight	0.792 g
Country of origin	Switzerland
European customs tariff number	85340090
GTIN	5713140277380
ETIM	EC002637
eCl@ss	27469090 PCB connection technology (other, unspecified)

Other materials or trace layouts on request!



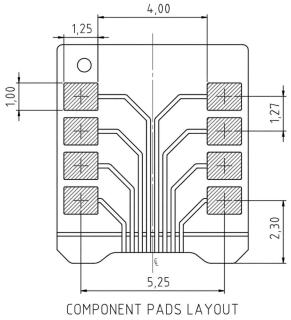


Drawing (dimensions in mm)

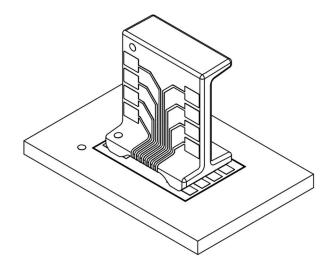


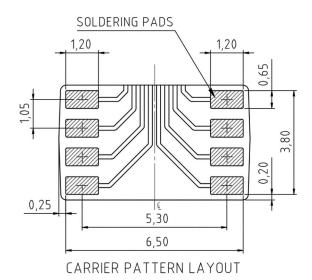


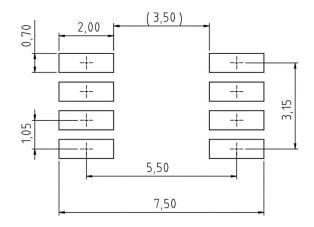
Drawing (dimensions in mm)







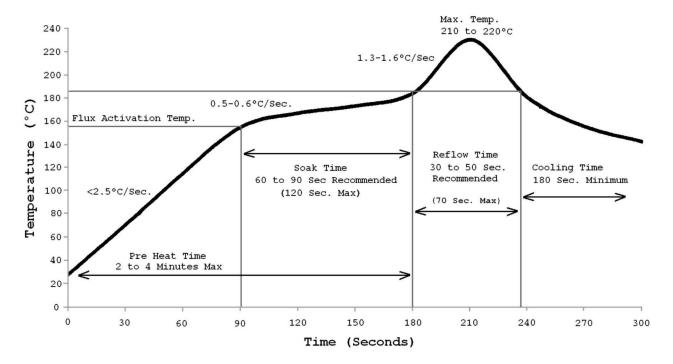




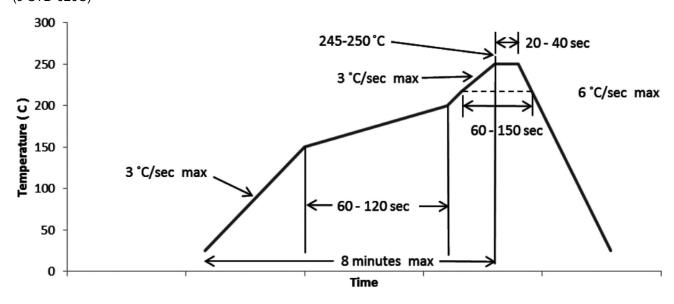
RECOMMENDED PCB PATTERN LAYOUT



Soldering instructions



PB-free soldering profile (J-STD-020C)



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Tape layout & packaging

BT807042

